

**QRF8-RA SERIES**

**(0.80 mm) .0315"**

# RIGHT-ANGLE GROUND PLANE SOCKET

## SPECIFICATIONS

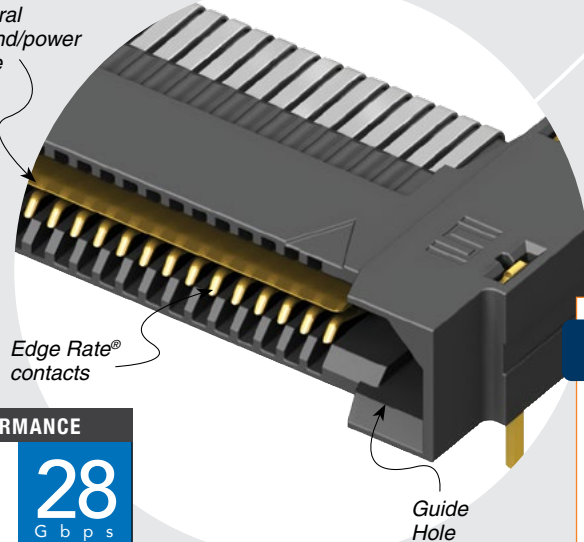
For complete specifications and recommended PCB layouts see [www.samtec.com?QRF8-RA](http://www.samtec.com?QRF8-RA)

- Insulator Material:**  
Black LCP
- Contact Material:**  
BeCu
- Ground Plane Material:**  
Phosphor Bronze
- Plating:**  
Au or Sn over  
50 μm (1.27 μm) Ni
- Current Rating (QRF8-RA/QRM8):**  
Contact:  
2.2 A per pin  
(2 pins powered)
- Ground Plane:**  
8.6 A per ground plane  
(1 ground plane powered)
- Operating Temp Range:**  
-55 °C to +125 °C
- Voltage Rating:**  
230 VAC / 325 VDC
- RoHS Compliant:**  
Yes

**Board Mates:**  
QRM8 (-GP required)



Integral ground/power plane



**RUGGEDIZED**  
BY SAMTEC

- Edge Rate® contacts
- Increased contact wipe
- Integral guide post

## HIGH-SPEED CHANNEL PERFORMANCE

**QRM8-RA/QRF8-RA**

Rating based on Samtec reference channel.  
For full SI performance data visit [Samtec.com](http://Samtec.com)  
or contact [SI@samtec.com](mailto:SI@samtec.com)

**28**  
Gbps

## PROCESSING

- Lead-Free Solderable:**  
Yes
- SMT Lead Coplanarity:**  
(0.10 mm) .004" max (026-052)  
(0.15 mm) .006" max (078)\*  
\*(.004" stencil solution may be available; contact [IPG@samtec.com](mailto:IPG@samtec.com))

## RECOGNITIONS

For complete scope of recognitions see [www.samtec.com/quality](http://www.samtec.com/quality)



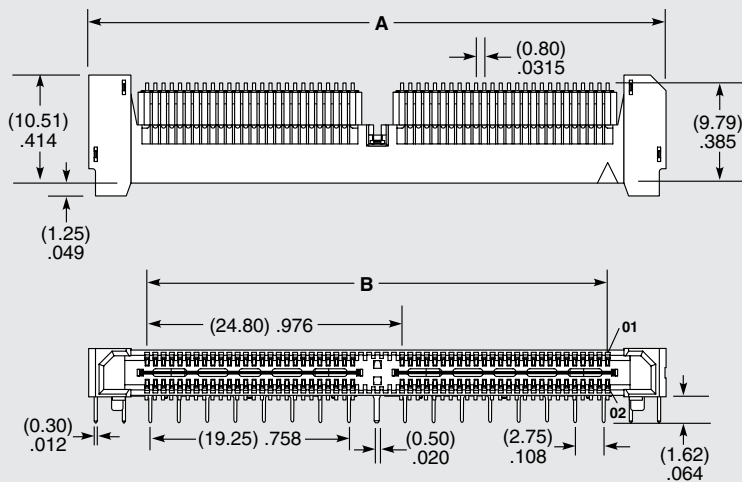
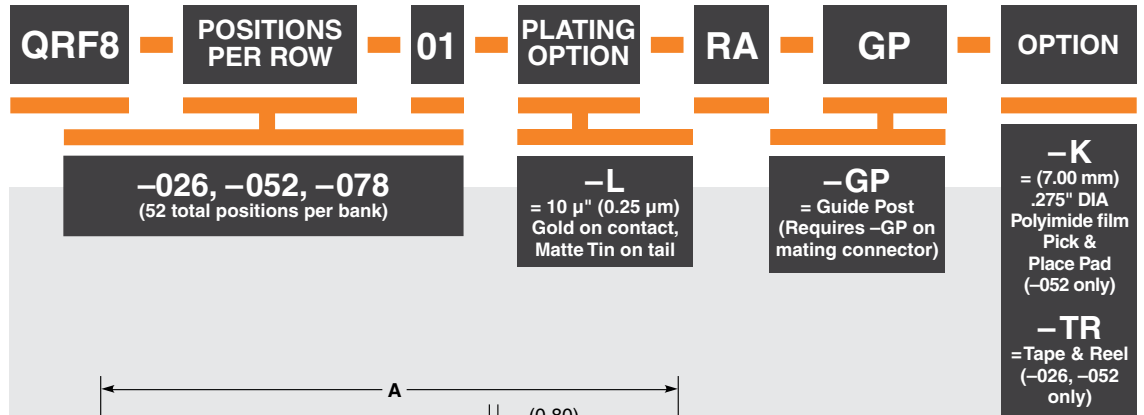
## ALSO AVAILABLE (MOQ Required)

- Other platings
- Contact Samtec.

**Notes:**  
Patented

For -GP (Guide Post option) to -GP (Guide Post option) mating.

Some lengths, styles and options are non-standard, non-returnable.



POSITIONS PER ROW	A	B
-026	(31.35) 1.234	(20.00) .787
-052	(56.15) 2.211	(44.80) 1.764
-078	(80.95) 3.187	(69.60) 2.740